

# VSTA065R29ANA

**Datasheet** 





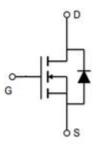
### 290mΩ, 650V, N-Channel Power MOSFET

#### VSTA065R29ANA

### **General Description**

V <sub>(BR)DSS</sub>	R <sub>DS(ON)_max</sub>	$I_D$
650V	290mΩ@10V	15A

# **Symbol**



Symbol of VSTA065R29ANA

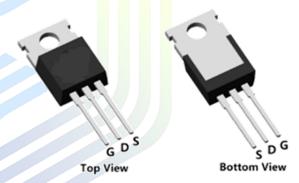
#### **Features**

- $V_{DS} = 650V, I_D = 15A$
- $\blacksquare R_{DS(ON) max} = 290 \text{m} \Omega @V_{GS} = 10 \text{V}$
- Extremely low switching loss
- Excellent stability and uniformity
- RoHS and Halogen-Free Compliant

# **Application**

- PC power
- LED lighting
- Telecom power
- Server power
- Solar/UPS

# Package Type



Package Type of VSTA065R29ANA

# **Ordering Information**

Product Name	Package	Marking		
VSTA065R29ANA	TO-220	STA065R29ANA		

#### VSTA065R29ANA

# **Absolute Maximum Ratings**

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	650	V
Gate-Source Voltage	$V_{GS}$	±30	V
Continuous Drain Current Note 1, T <sub>C</sub> =25°C	$I_D$	15	A
Pulsed Drain Current Note 2, T <sub>C</sub> =25°C	I <sub>D, pulse</sub>	45	A
Continuous Diode Forward Current Note 1, T <sub>C</sub> =25°C	$I_S$	15	A
Diode Pulsed Current Note 2, T <sub>C</sub> =25°C	I <sub>S, pulse</sub>	45	A
Max Power Dissipation Note 3, T <sub>C</sub> =25°C	$P_{\mathrm{D}}$	110	W
Avalanche Current, Single Pulse Note 4	I <sub>AS</sub>	6.5	A
Avalanche Energy, Single Pulse Note4	Eas	422	mJ
MOSFET dv/dt ruggedness, V <sub>DS</sub> =0~480V	dv/dt	50	V/ns
Reverse diode dv/dt, $V_{DS}=0\sim480V$ , $I_{SD}<=I_{D}$	dv/dt	15	V/ns
Operation and storage temperature	T <sub>J</sub> ,T <sub>STG</sub>	-55 to 150	°C

#### **Thermal Resistance**

Parameter	Symbol	Min	Тур	Max	Unit
Thermal Resistance, Junction-to-Case	$R_{ heta JC}$		1.14		°C/W
Thermal Resistance, Junction-to-Ambient Note5	$R_{ heta JA}$		62		C/W

#### **Notes:**

Note1: Calculated continuous current based on maximum allowable junction temperature.

Note2: Pulse width limited by safe operating area.

Note3: Based on max. junction temperature, using junction-case thermal resistance.

Note4: V<sub>DD</sub>=100V,V<sub>GS</sub>=10V, L=20mH, starting T<sub>A</sub>=25 °C.

Note5: When mounted on 1 inch square copper board, t≤10sec. The value in any given application depends on the user's specific board design.



#### VSTA065R29ANA

# **Electrical Characteristics**(T<sub>A</sub>= 25 °C, unless otherwise specified)

Parameter		Symbol	<b>Test Conditions</b>	Min	Тур	Max	Unit	
Statistic Characteristics				•				
Drain-Source Breakdown Voltage		$\mathrm{BV}_{\mathrm{DSS}}$	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	650			V	
Drain-Source Leakage Current		$I_{DSS}$	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V			1	uA	
Gate-Source Leakage Current	Forward	$I_{GSSF}$	V <sub>GS</sub> =30V, V <sub>DS</sub> =0V			100	nA	
	Reverse	$I_{GSSR}$	$V_{GS}$ =-30V, $V_{DS}$ =0V			-100		
Gate Threshold Voltage		$V_{\text{GS(TH)}}$	$V_{DS}=V_{GS}$ , $I_D=250uA$	2		4	V	
Drain-Source On-State Resistan	ce	$R_{\mathrm{DS(ON)}}$	$V_{GS}=10V, I_{D}=7.5A$		255	290	$m\Omega$	
Gate Resistance		$R_G$	F=1MHz, Open Drain		4.1		Ω	
Dynamic Characteristics								
Input Capacitance		C <sub>iss</sub>	V -50V V -0V		986		pF	
Output Capacitance		Coss	$V_{DS}$ =50V, $V_{GS}$ =0V, f=1MHz		105		pF	
Reverse Transfer Capacitance		$C_{rss}$	1—ПИПХ		2.29		pF	
Turn-on Delay Time		$t_{d(on)}$			17.8		ns	
Rise Time		$t_{\rm r}$	$V_{DS}$ =520V, $I_D$ =15A,		14.2			
Turn-off Delay Time		$t_{d(off)}$	$R_G=25\Omega$ , $V_{GS}=10V$		69.7			
Fall Time		$t_{\mathrm{f}}$			12.3			
Gate Charge Characteristics								
Gate to Source Charge		$Q_{\mathrm{gs}}$			5.86			
Gate to Drain Charge		$Q_{\mathrm{gd}}$	$V_{DS}$ =520V, $I_D$ =15A,		8.74		nC	
Gate Charge Total		Qg	V <sub>GS</sub> =0 to 10V		23.62			
Gate Plateau Voltage		V <sub>Plateau</sub>			5.45		V	
<b>Reverse Diode Characteristics</b>								
Drain-Source Diode Forward Voltage		$V_{\text{SD}}$	$V_{GS}=0V$ , $I_S=1A$		0.73		V	
Reverse Recovery Time		$t_{rr}$	V <sub>R</sub> =400V, I <sub>S</sub> =15A, di/dt=100A/us		271		ns	
Reverse Recovery Charge		$Q_{rr}$			3.9		uС	
Peak Reverse Recovery Current		I <sub>rrm</sub>	ul/ut=100A/us		25		A	
	<b>/ II</b>							



# **Electrical Characteristics Diagrams**

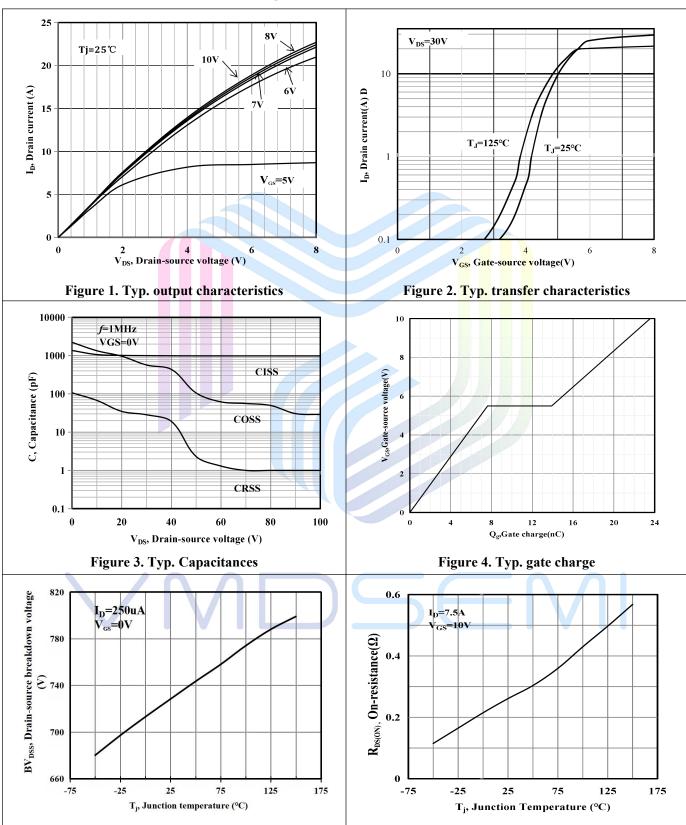
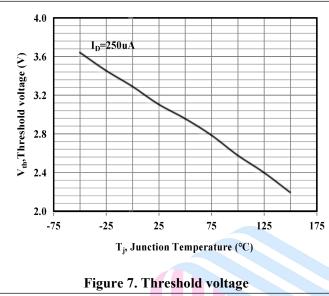


Figure 5. Drain-source breakdown voltage

Figure 6. Drain-source on-state resistance



#### VSTA065R29ANA



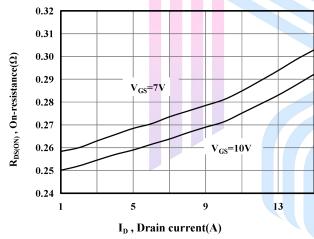
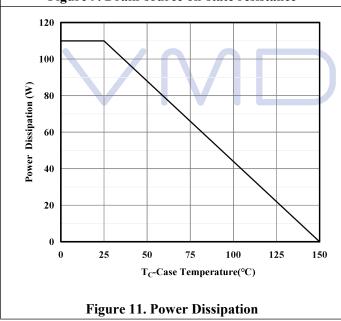


Figure 9. Drain-source on-state resistance



T<sub>j</sub>=125°C

T<sub>j</sub>=25°C

T<sub>j</sub>=25°C

0.1

0.4

0.5

0.6

0.7

0.8

0.9

1.0

V<sub>SD</sub>, Source-drain voltage(V)

Figure 8. Forward characteristic of body diode

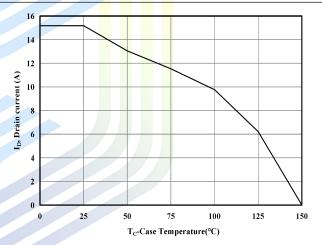


Figure 10. Drain current Derating

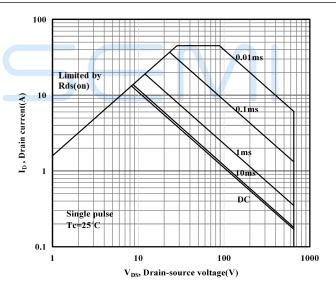
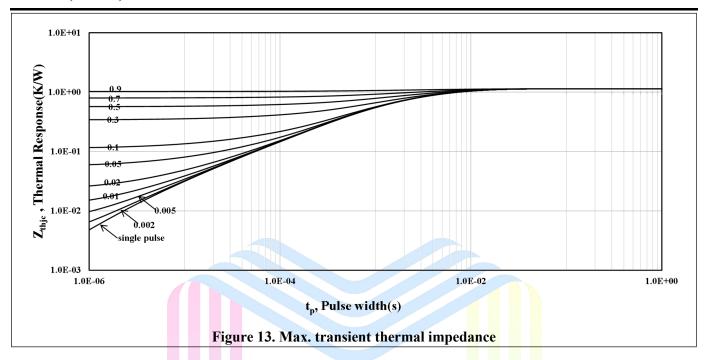


Figure 12. Safe operation area T<sub>c</sub>=25 °C



# $\overline{290m}\Omega$ , 650V, N-Channel Power MOSFET

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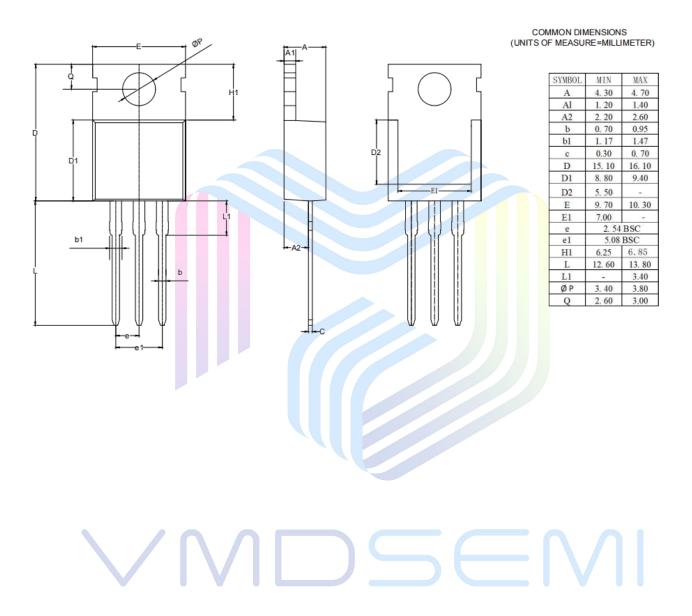




# 290mΩ, 650V, N-Channel Power MOSFET

### **Mechanical Dimensions**

#### **TO-220 Package Information**



#### 290mΩ, 650V, N-Channel Power MOSFET

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